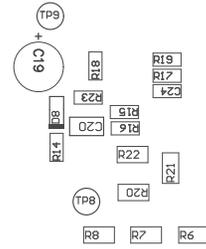


~~DNP~~

~~DNP~~



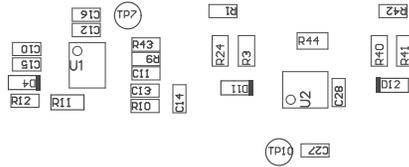
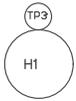
C21



TP8

- ZZ1 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ2 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ3 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

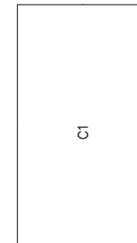
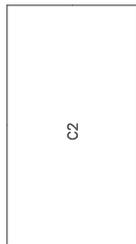
TP4



TP6



TP1



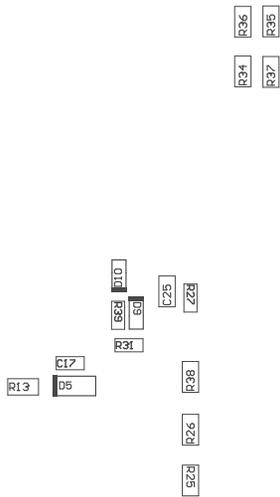
TP2



~~DNP~~

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00779	REV: B	SUN REV: Not In VersionControl
	TID #: TIDA-00779		
PLOT NAME = Top Assembly Drawing	GENERATED : 12/25/2015 15:21:03	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00779	REV: E1	SUN REV: Not In VersionControl
	TID #: TIDA-00779		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/25/2015 15:21:04		TEXAS INSTRUMENTS

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